

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Wei Zhong Cao</td><td>10/26/2005</td></tr><tr><td>Wai Leong Yip</td><td>10/26/2005</td></tr><tr><td>Wen Jen Ronald Yeu</td><td>10/24/2005</td></tr><tr><td>Hong Kiat Chia</td><td>10/21/2005</td></tr></tbody></table>		Name	Execution Date	Wei Zhong Cao	10/26/2005	Wai Leong Yip	10/26/2005	Wen Jen Ronald Yeu	10/24/2005	Hong Kiat Chia	10/21/2005
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Wen Jen Ronald Yeu	10/24/2005										
Hong Kiat Chia	10/21/2005										
RECEIVING PARTY DATA											
Name:	Systems on Silicon Manufacturing Co. PTE. Ltd.										
Street Address:	70, Pasir Ris Industrial Drive 1										
City:	Singapore										
State/Country:	SINGAPORE										
Postal Code:	519527										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11261142</td></tr></tbody></table>		Property Type	Number	Application Number:	11261142						
Property Type	Number										
Application Number:	11261142										
CORRESPONDENCE DATA											
Fax Number:	(314)726-7501										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
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Address Line 4:	St. Louis, MISSOURI 63105										
ATTORNEY DOCKET NUMBER:	5731-000019/US										
NAME OF SUBMITTER:	Matthew L. Cutler										

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PATENT  
REEL: 016954 FRAME: 0205

**Total Attachments: 5**

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## ASSIGNMENT

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has  
invented:

Atty. Docket No.  
5731-000019/US

### ANALYZER MAGNET CHAMBER LINER

for which Assignor is about to make or has made United States or International application for patent

- (a) ☒ executed on even date preparatory to filing (each inventor should sign this Assignment on the same day as he/she signs the Declaration and Power of Attorney);
- (b) ☐ executed on \_\_\_\_\_, \_\_\_\_\_, \_\_\_\_\_; or
- (c) ☐ filed on \_\_\_\_\_, and assigned Serial No. \_\_\_\_\_ or PCT International Application No. \_\_\_\_\_, and

WHEREAS, Systems On Silicon Manufacturing Co. PTE. Ltd., hereinafter referred to as Assignee, is desirous of acquiring an interest therein:

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy whereof is hereby acknowledged, Assignor by these presents does sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and all foreign countries, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the said invention as described in the aforesaid application, said application for patent and all Letters Patent therefor to be held and enjoyed by Assignee to the full end of the term for which said Letters Patent are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letter patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, for the benefit of Assignee without further or other compensation than that above set forth;


Assignor hereby covenants that no assignment, sale or agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the Commissioner of Patents and Trademarks to issue said Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue said Letters Patent, Utility Model Registration or Inventor's Certificate to Assignee.

Assignor hereby authorizes and requests my attorney to insert here in parentheses (Application No. 11/261,142, filed 10/28/05) the filing date and application number of said application when known.

## ASSIGNMENT

Full name of sole or first inventor: Cao, Wei Zhong

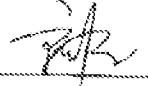
Inventor's signature: 

Date: 26-OCT-05

Residence: Blk 767, Pasir Ris Street 71, #10-320, Singapore 510767

Citizenship: Chinese


Mailing Address: Blk 767, Pasir Ris Street 71, #10-320, Singapore 510767

 WONG LIANG KEE  
Witness

Witness

## ASSIGNMENT

Full name of second joint inventor, if any: Yip, Wai Leong

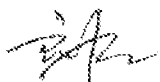
Inventor's signature: 

Date: 26-01-05

Residence: Blk 16, Cactus Drive, #03-03, Singapore 809690

Citizenship: Singaporean

Mailing Address: Blk 16, Cactus Drive, #03-03, Singapore 809690

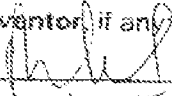
 Wong LIANG KEE

Witness

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## ASSIGNMENT

Full name of third joint inventor, if any: Yeu, Wen Jen Ronald


Inventor's signature: 

Date: 24 Oct 05

Residence: Blk 708, Choa Chu Kang Street 53, #11-08, Singapore 680708

Citizenship: Singaporean

Mailing Address: Blk 708, Choa Chu Kang Street 53, #11-08, Singapore 680708

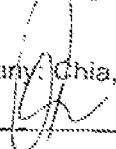
 WONG LIANG KEE

Witness

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## ASSIGNMENT

Full name of fourth joint inventor, if any: Chia, Hong Kiat

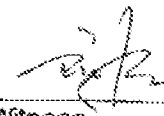
Inventor's signature: 

Date: 21.07.05

Residence: Blk 193, Toa Payoh Lorong 4, #13-660, Singapore 310193

Citizenship: Singaporean

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 Wally Lim KEE  
Witness

\_\_\_\_\_  
Witness